

Am27C040

4 Megabit (512 K x 8-Bit) CMOS EPROM

DISTINCTIVE CHARACTERISTICS

- Fast access time
 - Available in speed options as fast as 90 ns
- **■** Low power consumption
 - <10 µA typical CMOS standby current</p>
- **■** JEDEC-approved pinout
 - Plug-in upgrade for 1 Mbit and 2 Mbit EPROMs
 - Easy upgrade from 28-pin JEDEC EPROMs

- Single +5 V power supply
- ±10% power supply tolerance standard
- 100% Flashrite[™] programming
 - Typical programming time of 1 minute
- Latch-up protected to 100 mA from −1 V to V_{CC} + 1 V
- **■** High noise immunity
- Compact 32-pin DIP, PDIP, PLCC packages

GENERAL DESCRIPTION

The Am27C040 is a 4 Mbit ultraviolet erasable programmable read-only memory. It is organized as 512K bytes, operates from a single +5 V supply, has a static standby mode, and features fast single address location programming. The device is available in windowed ceramic DIP packages and plastic one-time programmable (OTP) packages.

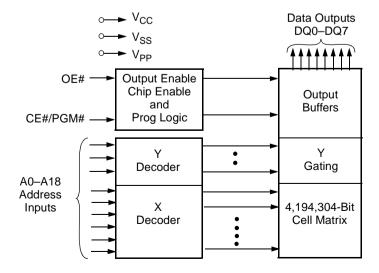
Data can be typically accessed in less than 90 ns, allowing high-performance microprocessors to operate without any WAIT states. The device offers separate Output Enable (OE#) and Chip Enable (CE#) controls,

thus eliminating bus contention in a multiple bus microprocessor system.

AMD's CMOS process technology provides high speed, low power, and high noise immunity. Typical power consumption is only 100 mW in active mode, and 50 μ W in standby mode.

All signals are TTL levels, including programming signals. Bit locations may be programmed singly, in blocks, or at random. The device supports AMD's Flashrite programming algorithm (100 µs pulses) resulting in typical programming time of 1 minute.

BLOCK DIAGRAM



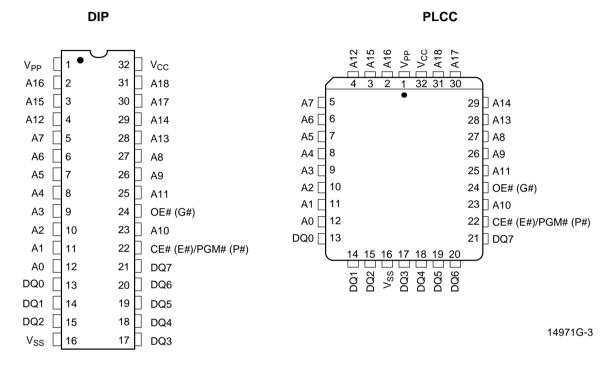
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PRODUCT SELECTOR GUIDE

Family Part Number	Am27C040						
Speed Options (V _{CC} = 5.0 V ± 10%)	-90	-120	-150	-200			
Max Access Time (ns)	90	120	150	200			
CE# (E#) Access (ns)		120	150	200			
OE# (G#) Access (ns)	40 50 65 7						

CONNECTION DIAGRAMS

Top View



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Notes:

- 1. JEDEC nomenclature is in parenthesis.
- 2. The 32-pin DIP to 32-pin PLCC configuration varies from the JEDEC 28-pin DIP to 32-pin PLCC configuration.

PIN DESIGNATIONS

A0-A18 = Address Inputs

CE# (E#)/PGM# (P#)= Chip Enable/Program Enable Input

DQ0-DQ7 = Data Inputs/Outputs

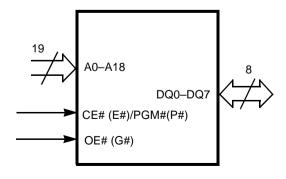
OE# (G#) = Output Enable Input

V_{CC} = V_{CC} Supply Voltage

V_{PP} = Program Voltage Input

V_{SS} = GroundLogic Symbol

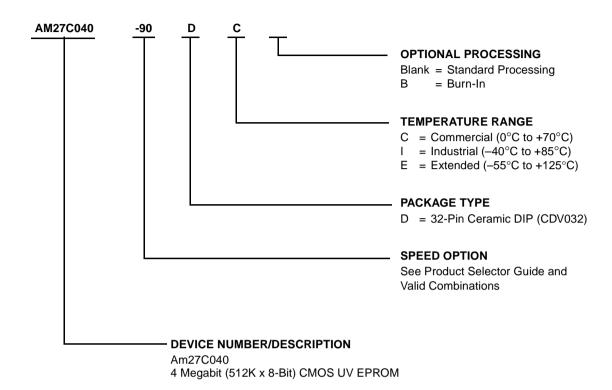
LOGIC SYMBOL



14971E-4

ORDERING INFORMATION UV EPROM Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of:



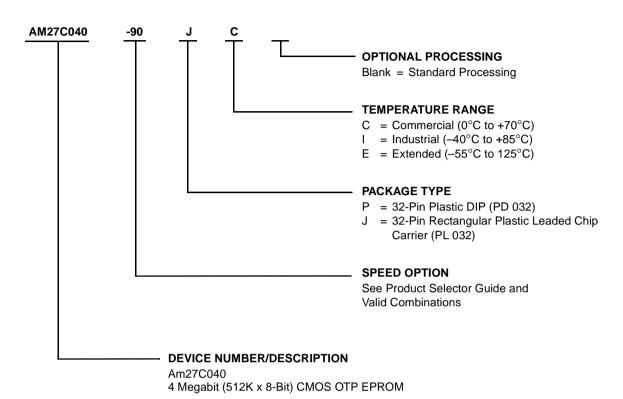
Valid Combinations					
AM27C040-90					
AM27C040-120	DC DCB DI DIB DE DEB				
AM27C040-150	DC, DCB, DI, DIB, DE, DEB				
AM27C040-200					

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Valid Combinations

ORDERING INFORMATION OTP EPROM Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of:



Valid Combinations					
AM27C040-90					
AM27C040-120	PC, PI, JC, JI				
AM27C040-150	FO, FI, JO, JI				
AM27C040-200					

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

FUNCTIONAL DESCRIPTION

Device Erasure

In order to clear all locations of their programmed contents, the device must be exposed to an ultraviolet light source. A dosage of 15 W seconds/cm² is required to completely erase the device. This dosage can be obtained by exposure to an ultraviolet lamp — wavelength of 2537 Å — with intensity of 12,000 $\mu\text{W/cm}^2$ for 15 to 20 minutes. The device should be directly under and about one inch from the source and all filters should be removed from the UV light source prior to erasure.

Note that all UV erasable devices will erase with light sources having wavelengths shorter than 4000 Å, such as fluorescent light and sunlight. Although the erasure process happens over a much longer time period, exposure to any light source should be prevented for maximum system reliability. Simply cover the package window with an opaque label or substance.

Device Programming

Upon delivery, or after each erasure, the device has all of its bits in the "ONE", or HIGH state. "ZEROs" are loaded into the device through the programming procedure.

The programming mode is entered when 12.75 V \pm 0.25 V is applied to the V $_{PP}$ pin, CE#/PGM# is at V $_{IL}$ and OE# is at V $_{IH}$.

For programming, the data to be programmed is applied 8 bits in parallel to the data output pins.

The flowchart in the EPROM Products Data Book, Programming section (Section 5, Figure 5-1) shows AMD's Flashrite algorithm. The Flashrite algorithm reduces programming time by using a 100 μ s programming pulse and by giving each address only as many pulses to reliably program the data. After each pulse is applied to a given address, the data in that address is verified. If the data does not verify, additional pulses are given until it verifies or the maximum pulses allowed is reached. This process is repeated while sequencing through each address of the device. This part of the algorithm is done at $V_{CC} = 6.25$ V to assure that each EPROM bit is programmed to a sufficiently high threshold voltage. After the final address is completed, the entire EPROM memory is verified at $V_{CC} = V_{PP} = 5.25$ V.

Please refer to the EPROM Products Data Book, Section 5 for the programming flow chart and characteristics.

Program Inhibit

Programming different data to multiple devices in parallel is easily accomplished. Except for CE#/PGM#, all like inputs of the devices may be common. A TTL low-level program pulse applied to one device's CE#/PGM# input with $V_{PP}=12.75~V\pm0.25~V$ will program

that particular device. A high-level CE#/PGM# input inhibits the other devices from being programmed.

Program Verify

A verification should be performed on the programmed bits to determine that they were correctly programmed. The verify should be performed with OE# at V_{IL} , CE#/PGM# at V_{IH} , and V_{PP} between 12.5 V and 13.0 V.

Auto Select Mode

The autoselect mode provides manufacturer and device identification through identifier codes on DQ0–DQ7. This mode is primarily intended for programming equipment to automatically match a device to be programmed with its corresponding programming algorithm. This mode is functional in the 25°C \pm 5°C ambient temperature range that is required when programming the device.

To activate this mode, the programming equipment must force V_H on address line A9. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from V_{IL} to V_{IH} (that is, changing the address from 00h to 01h). All other address lines must be held at V_{II} during the autoselect mode.

Byte 0 (A0 = V_{IL}) represents the manufacturer code, and Byte 1 (A0 = V_{IH}), the device identifier code. Both codes have odd parity, with DQ7 as the parity bit.

Read Mode

To obtain data at the device outputs, Chip Enable (CE#/PGM#) and Output Enable (OE#) must be driven low. CE#/PGM# controls the power to the device and is typically used to select the device. OE# enables the device to output data, independent of device selection. Addresses must be stable for at least t_{ACC}-t_{OE}. Refer to the Switching Waveforms section for the timing diagram.

Standby Mode

The device enters the CMOS standby mode when CE#/PGM# is at $V_{CC}\pm0.3$ V. Maximum V_{CC} current is reduced to 100 $\mu A.$ The device enters the TTL-standby mode when CE#/PGM# is at $V_{IH}.$ Maximum V_{CC} current is reduced to 1.0 mA. When in either standby mode, the device places its outputs in a high-impedance state, independent of the OE# input.

Output OR-Tieing

To accommodate multiple memory connections, a two-line control function is provided to allow for:

- Low memory power dissipation, and
- Assurance that output bus contention will not occur CE#/PGM# should be decoded and used as the primary device-selecting function, while OE# be made a

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common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low-power standby mode and that the output pins are only active when data is desired from a particular memory device.

System Applications

During the switch between active and standby conditions, transient current peaks are produced on the rising and falling edges of Chip Enable. The magnitude of

these transient current peaks is dependent on the output capacitance loading of the device. At a minimum, a 0.1 μF ceramic capacitor (high frequency, low inherent inductance) should be used on each device between V_{CC} and V_{SS} to minimize transient effects. In addition, to overcome the voltage drop caused by the inductive effects of the printed circuit board traces on EPROM arrays, a 4.7 μF bulk electrolytic capacitor should be used between V_{CC} and V_{SS} for each eight devices. The location of the capacitor should be close to where the power supply is connected to the array.

MODE SELECT TABLE

Mode		CE#/PGM#	OE#	A0	A9	V _{PP}	Outputs
Read		V _{IL}	V_{IL}	Х	Х	Х	D _{OUT}
Output Disable		V _{IL}	V _{IH}	Х	Х	Х	HIGH Z
Standby (TTL)		V _{IH}	Х	Х	Х	Х	HIGH Z
Standby (CMOS)		V _{CC} + 0.3 V	Х	Х	Х	Х	HIGH Z
Program		V _{IL}	V_{IH}	Х	Х	V _{PP}	D _{IN}
Program Verify		V _{IL}	V_{IL}	X	Х	V _{PP}	D _{OUT}
Program Inhibit		V _{IH}	Х	Х	Х	V_{PP}	HIGH Z
Auto Select (Note 3)	Manufacturer Code	V _{IL}	V _{IL}	V _{IL}	V _H	Х	01h
	Device Code	V _{IL}	V _{IL}	V _{IH}	V _H	Х	9Bh

Note:

- 1. $V_H = 12.0 \text{ V} \pm 0.5 \text{ V}$.
- 2. $X = Either V_{IH} or V_{IL}$
- 3. $A1 A8 = A10 A18 = V_{II}$
- 4. See DC Programming Characteristics in the EPROM Products Data Book for V_{PP} voltage during programming

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	
OTP Products	,C
All Other Products65°C to +150°	,C
Ambient Temperature with Power Applied55°C to + 125°	°C
Voltage with Respect to V _{SS}	
All pins except A9, V _{PP} , V _{CC} (Note 1)0.6 V to V _{CC} +0.5	٧
A9 and V _{PP} (Note 2)0.6 V to +13.5	٧
V _{CC} 0.6 V to +7.0	٧

- 1. During voltage transitions, inputs may overshoot V_{SS} to 2.0 V for periods of up to 20 ns. Maximum DC voltage on input and I/O pins may overshoot to V_{CC} + 2.0 V for periods up to 20 ns.
- 2. During voltage transitions, A9 and V_{PP} may overshoot V_{SS} to -2.0 V for periods of up to 20 ns. A9 and V_{PP} must not exceed +13.5 V at any time.

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure of the device to absolute maximum rating conditions for extended periods may affect device reliability.

OPERATING RANGES

Commercial	(C)	Devices

Commercial (C) Devices
Ambient Temperature (T _A)0°C to +70°C
Industrial (I) Devices
Ambient Temperature (T _A)40°C to +85°C
Extended (E) Devices
Ambient Temperature (T _A)55°C to +125°C
Supply Read Voltages
V_{CC} for ± 5% devices +4.75 V to +5.25 V
V_{CC} for ± 10% devices +4.50 V to +5.50 V

Operating ranges define those limits between which the functionality of the device is quaranteed.

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DC CHARACTERISTICS over operating ranges unless otherwise specified

Parameter Symbol	Parameter Description	Test Condition	Min	Max	Unit	
V _{OH}	Output HIGH Voltage	I _{OH} = -400 μA		2.4		V
V _{OL}	Output LOW Voltage	I _{OL} = 2.1 mA			0.45	V
V _{IH}	Input HIGH Voltage			2.0	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage			-0.5	+0.8	V
	Input Load Current	$V_{IN} = 0 \text{ V to } V_{CC}$	C/I Devices		1.0	
I _{LI}			E Devices		5.0	μΑ
I _{LO}	Output Leakage Current	V _{OUT} = 0 V to V _{CC}			5.0	μΑ
	V _{CC} Active Current (Note 3)	CE# = V _{IL} , f = 10 MHz,	C/I Devices		40	A
I _{CC1}		I _{OUT} = 0 MA	E Devices		60	mA
I _{CC2}	V _{CC} TTL Standby Current	CE# = V _{IH}			1.0	mA
I _{CC3}	V _{CC} CMOS Standby Current	CE# = V _{CC} ± 0.3 V			100	μA
I _{PP1}	V _{PP} Current During Read	$CE\# = OE\# = V_{IL}, V_{PP}$ = V_{CC}			100	μΑ

Caution: The device must not be removed from (or inserted into) a socket when V_{CC} or V_{PP} is applied.

Notes.

- 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}
- 2. I_{CC1} is tested with $OE\# = V_{IH}$ to simulate open outputs.
- 3. Minimum DC Input Voltage is -0.5. During transitions, the inputs may overshoot to -2.0 V for periods less than 20 ns. Maximum DC Voltage on output pins is Vcc +0.5 V, which may overshoot to $V_{CC} +2.0$ V for periods less than 20 ns.

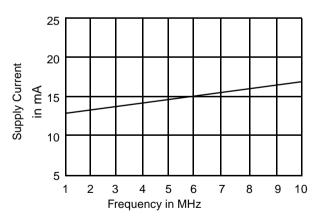


Figure 1. Typical Supply Current vs. Frequency $V_{CC} = 5.5 \text{ V}, T = 25^{\circ}\text{C}$

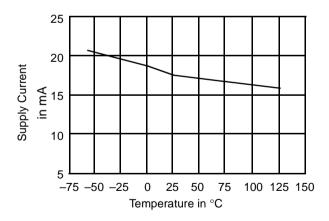
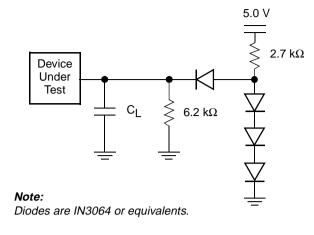


Figure 2. Typical Supply Current vs. Temperature $V_{CC} = 5.5 \text{ V}, f = 10 \text{ MHz}$

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TEST CONDITIONS



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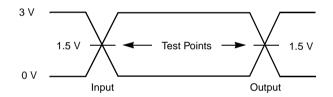
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Table 1. Test Specifications

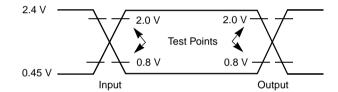
Test Condition	All	Unit
Output Load	1 TTL gate	
Output Load Capacitance, C _L (including jig capacitance)	100	pF
Input Rise and Fall Times	≤ 20	ns
Input Pulse Levels	0.45-2.4	V
Input timing measurement reference levels	0.8, 2.0	V
Output timing measurement reference levels	0.8, 2.0	V

Figure 1. Test Setup

SWITCHING TEST WAVEFORM



Note: For $C_L = 30$ pF.



Note: For $C_L = 100 pF$.

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KEY TO SWITCHING WAVEFORMS

WAVEFORM	INPUTS	OUTPUTS				
	Steady					
	Changing from H to L					
	Cha	anging from L to H				
XXXXX	Don't Care, Any Change Permitted	Changing, State Unknown				
<u></u> >>→	Does Not Apply Center Line is High Impedance State (Hig					

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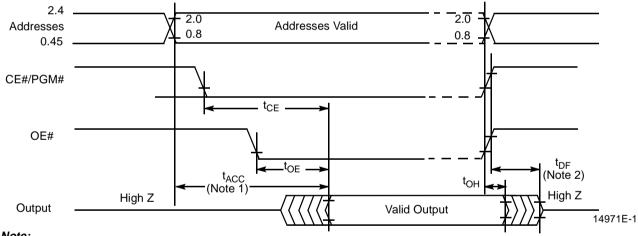
AC CHARACTERISTICS

Parameter Symbols									
JEDEC	Std.	Description	Test Setup		-90	-120	-150	-200	Unit
t _{AVQV}	t _{ACC}	Address to Output Delay	CE# = OE# = V _{IL}	Max	90	120	150	200	ns
t _{ELQV}	t _{CE}	Chip Enable to Output Delay	OE# = V _{IL}	Max	90	120	150	200	ns
t _{GLQV}	t _{OE}	Output Enable to Output Delay	CE# = V _{IL}	Max	40	50	65	75	ns
t _{EHQZ} t _{GHQZ}	t _{DF} (Note 2)	Chip Enable High or Output Enable High, Whichever Occurs First, to Output High Z		Max	30	30	30	40	ns
t _{AXQX}	t _{ОН}	Output Hold Time from Addresses, CE# or OE#, Whichever Occurs First		Min	0	0	0	0	ns

Caution: Do not remove the device from (or inserted into) a socket when V_{CC} or V_{PP} is applied.

- 1. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}
- 2. This parameter is sampled and not 100% tested.
- 3. Switching characteristics are over operating range, unless otherwise specified.
- 4. See Figure 1 and Table 1 for test specifications.

SWITCHING WAVEFORMS



Note:

- 1. OE# may be delayed up to t_{ACC} t_{OE} after the falling edge of the addresses without impact on t_{ACC} .
- 2. t_{DF} is specified from OE# or CE#, whichever occurs first.

PACKAGE CAPACITANCE

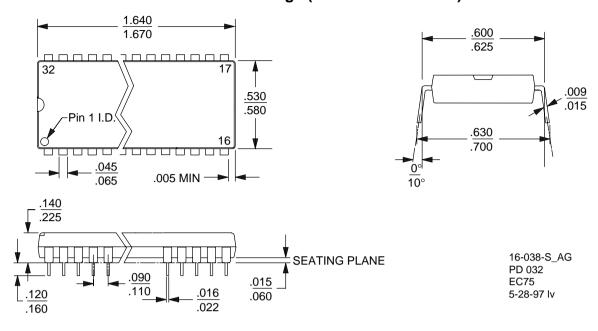
Parameter Parameter		Test	CDV032		PD 032		PL 032		
Symbol	Description	Conditions	Тур	Max	Тур	Max	Тур	Max	Unit
C _{IN}	Input Capacitance	V _{IN} = 0 V	10	12	10	12	8	10	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0 V	12	15	12	15	9	12	pF

Notes:

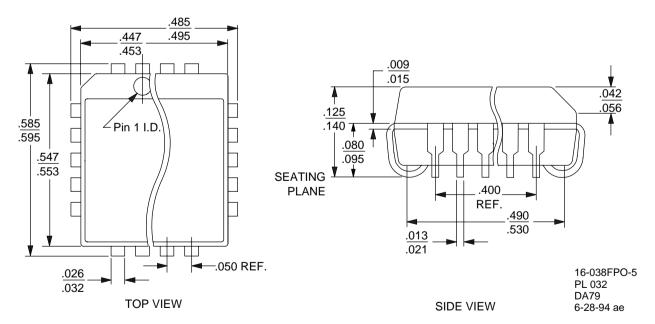
- 1. This parameter is only sampled and not 100% tested.
- 2. $T_A = +25^{\circ}C$, f = 1 MHz.

PHYSICAL DIMENSIONS

PD 032—32-Pin Plastic Dual In-Line Package (measured in inches)

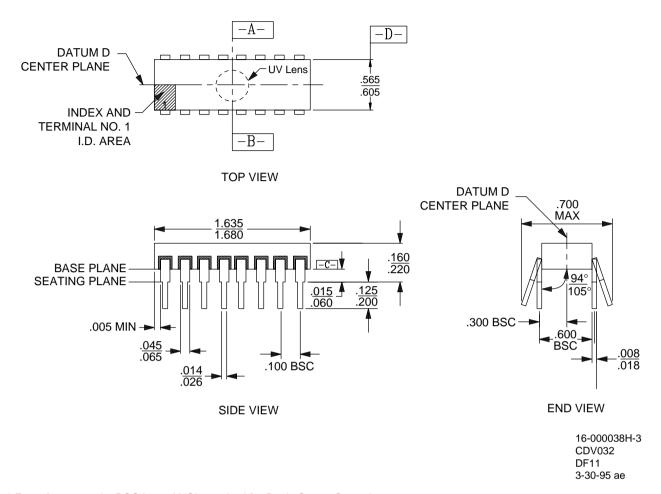


PL 032—32-Pin Plastic Leaded Chip Carrier (measured in inches)



PHYSICAL DIMENSIONS*

CDV032—32-Pin Ceramic DIP, UV Lens (measured in inches)



^{*} For reference only. BSC is an ANSI standard for Basic Space Centering.

REVISION SUMMARY FOR AM27C040

Revision E/1

Product Selector Guide:

Added -90 (90 ns, $\pm 10\%~V_{CC})$ and deleted -100 speed options.

Ordering Information, UV EPROM Products:

The -90 part number is now listed in the example.

Valid Combinations: Added -90 and deleted -100 speed options in valid combinations.

Ordering Information, OTP EPROM Products:

The -90 part number is now listed in the example.

Valid Combinations: Added -90 and deleted -100 speed options in valid combinations.

Programming the Am27C040:

The fourth paragraph should read, "Please refer to Section 5 for programming...".